

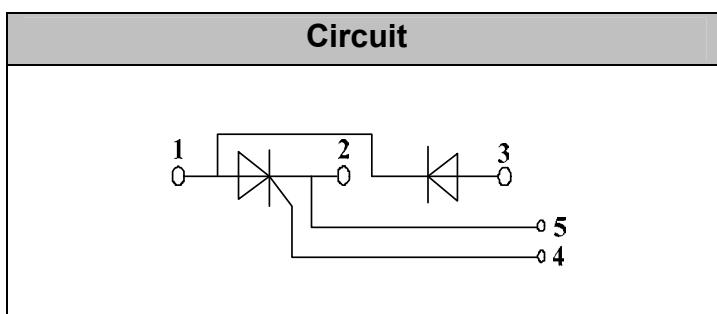
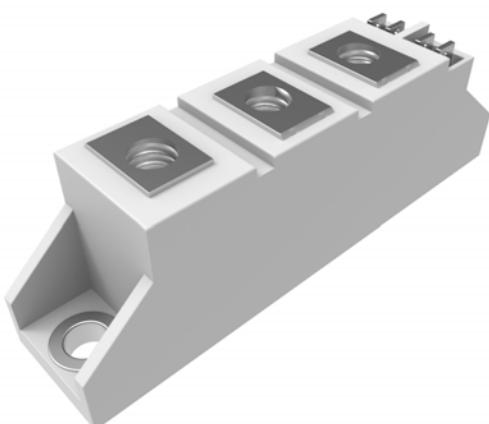
## Features

- International standard package
- Heat transfer through aluminum oxide DBC ceramic isolated metal baseplate
- Glass passivated chip
- Simple Mounting

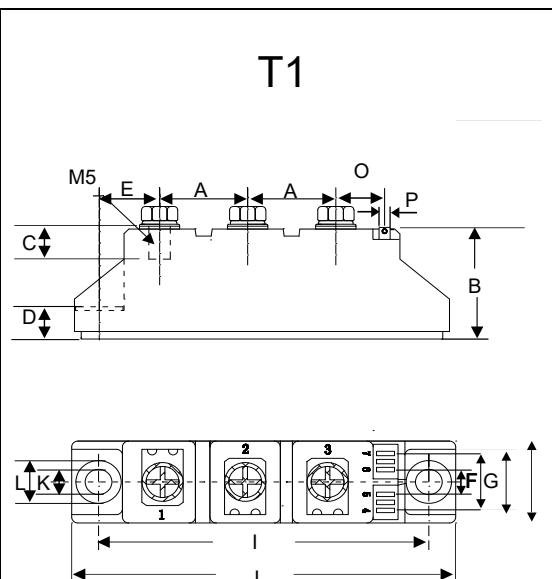
## Applications

- Power Converters
- Lighting Control
- DC Motor Control and Drives
- Heat and temperature control

MCC Part Number	V <sub>RRM</sub>	V <sub>RSM</sub>
MT110CB16T1	1600V	1700V
MT110CB18T1	1800V	1900V



**110 Amp  
THYRISTOR  
MODULE  
1600~1800 Volts**



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.776	0.799	19.50	20.50	
B	1.169	1.193	29.50	30.50	
C	0.343	0.366	8.50	9.50	
D	0.323	0.346	8.00	9.00	
E	0.602	0.622	15.10	16.00	
F	0.224	0.248	5.50	6.50	
G	0.539	0.563	13.50	14.50	
H	0.657	0.681	16.50	17.50	
I	3.138	3.161	79.50	80.50	
J	3.650	3.673	92.50	93.50	
K	0.256		6.50		Ø
L	0.421	0.445	10.50	11.50	
M	0.815	0.839	20.50	21.50	
O	0.579	0.602	14.50	15.50	
P	0.11X0.032		2.8X0.8		

**◆Diode****Maximum Ratings**

<b>Symbol</b>	<b>Item</b>	<b>Conditions</b>	<b>Values</b>	<b>Units</b>
ID	Output Current(D.C.)	Tc=85°C	110	A
IFSM	Surge forward current	t=10mS Tvj =45°C	2250	A
i <sup>2</sup> t	Circuit Fusing Consideration		25000	A <sup>2</sup> s
Visol	Isolation Breakdown Voltage(R.M.S)	a.c.50HZ;r.m.s.;1min	3000	V
Tvj	Operating Junction Temperature		-40 to +125	°C
Tstg	Storage Temperature		-40 to +125	°C
Mt	Mounting Torque	To terminals(M5)	3±15%	Nm
Ms		To heatsink(M6)	5±15%	Nm
Weight	Module (Approximately)		100	g

**Thermal Characteristics**

<b>Symbol</b>	<b>Item</b>	<b>Conditions</b>	<b>Values</b>	<b>Units</b>
R <sub>th(j-c)</sub>	Thermal Impedance, max.	Junction to Case	0.14	°C/W
R <sub>th(c-s)</sub>	Thermal Impedance, max.	Case to Heatsink	0.10	°C/W

**Electrical Characteristics**

<b>Symbol</b>	<b>Item</b>	<b>Conditions</b>	<b>Values</b>			<b>Units</b>
			<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	
V <sub>FM</sub>	Forward Voltage Drop, max.	T=25°C IF =300A			1.65	V
I <sub>RRM</sub>	Repetitive Peak Reverse Current, max.	T <sub>vj</sub> =25°C V <sub>RD</sub> =V <sub>RRM</sub> T <sub>vj</sub> =125°C V <sub>RD</sub> =V <sub>RRM</sub>	≤0.5 ≤6			mA mA

## ◆Thyristor

### Maximum Ratings

Symbol	Item	Conditions	Values	Units
I <sub>TAV</sub>	Average On-State Current	Sine 180°; T <sub>c</sub> =85°C	110	A
I <sub>TSM</sub>	Surge On-State Current	T <sub>VJ</sub> =45°C t=10ms, sine T <sub>VJ</sub> =125°C t=10ms, sine	2250 1900	A
i <sup>2</sup> t	Circuit Fusing Consideration	T <sub>VJ</sub> =45°C t=10ms, sine T <sub>VJ</sub> =125°C t=10ms, sine	25000 18000	A2s
Visol	Isolation Breakdown Voltage(R.M.S)	a.c.50HZ;r.m.s.;1min	3000	V
T <sub>vj</sub>	Operating Junction Temperature		-40 to +130	°C
T <sub>tsg</sub>	Storage Temperature		-40 to +125	°C
M <sub>t</sub>	Mounting Torque	To terminals(M5)	3±15%	Nm
M <sub>s</sub>		To heatsink(M6)	5±15%	Nm
di/dt	Critical Rate of Rise of On-State Current	T <sub>VJ</sub> =T <sub>VJM</sub> , 2/3V <sub>DRM</sub> , I <sub>G</sub> =500mA Tr<0.5us, tp>6us	150	A/us
dv/dt	Critical Rate of Rise of Off-State Voltage, min.	T <sub>J</sub> =T <sub>VJM</sub> , 2/3V <sub>DRM</sub> linear voltage rise	1000	V/us
a	Maximum allowable acceleration		50	m/s <sup>2</sup>

### Thermal Characteristics

Symbol	Item	Conditions	Values	Units
R <sub>th(j-c)</sub>	Thermal Impedance, max.	Junction to Case	0.28	°C/W
R <sub>th(c-s)</sub>	Thermal Impedance, max.	Case to Heatsink	0.20	°C/W

### Electrical Characteristics

Symbol	Item	Conditions	Values			Units
			Min.	Typ.	Max.	
V <sub>TM</sub>	Peak On-State Voltage, max.	T=25°C I <sub>T</sub> =300A			1.65	V
I <sub>RRM</sub> /I <sub>DRM</sub>	Repetitive Peak Reverse Current, max. / Repetitive Peak Off-State Current, max.	T <sub>VJ</sub> =T <sub>VJM</sub> , V <sub>R</sub> =V <sub>RRM</sub> , V <sub>D</sub> =V <sub>DRM</sub>			20	mA
V <sub>TO</sub>	On state threshold voltage	For power-loss calculations only (T <sub>VJ</sub> =125°C)			0.9	V
r <sub>T</sub>	Value of on-state slope resistance, max	T <sub>VJ</sub> =T <sub>VJM</sub>			2	mΩ
V <sub>GT</sub>	Gate Trigger Voltage, max.	T <sub>VJ</sub> =25°C, V <sub>D</sub> =6V			3	V
I <sub>GT</sub>	Gate Trigger Current, max.	T <sub>VJ</sub> =25°C, V <sub>D</sub> =6V			150	mA
V <sub>GD</sub>	Non-triggering gate voltage, max.	T <sub>VJ</sub> =125°C, V <sub>D</sub> =2/3V <sub>DRM</sub>			0.25	V
I <sub>GD</sub>	Non-triggering gate current, max.	T <sub>VJ</sub> =125°C, V <sub>D</sub> =2/3V <sub>DRM</sub>			6	mA
I <sub>L</sub>	Latching current, max.	T <sub>VJ</sub> =25°C, R <sub>G</sub> =33 Ω		300	600	mA
I <sub>H</sub>	Holding current, max.	T <sub>VJ</sub> =25°C, V <sub>D</sub> =6V		150	250	mA
t <sub>gd</sub>	Gate controlled delay time	T <sub>VJ</sub> =25°C, I <sub>G</sub> =1A, dI <sub>G</sub> /dt=1A/us			1	us
t <sub>q</sub>	Circuit commutated turn-off time	T <sub>VJ</sub> =T <sub>VJM</sub>			100	us

## Performance Curves

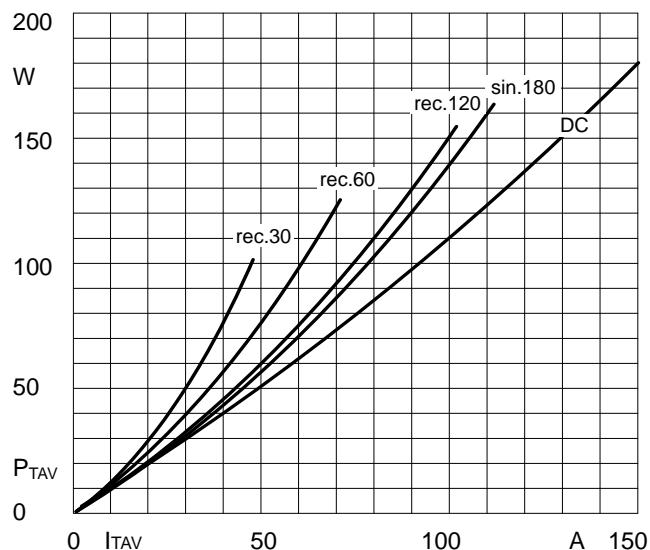


Fig1. Power dissipation

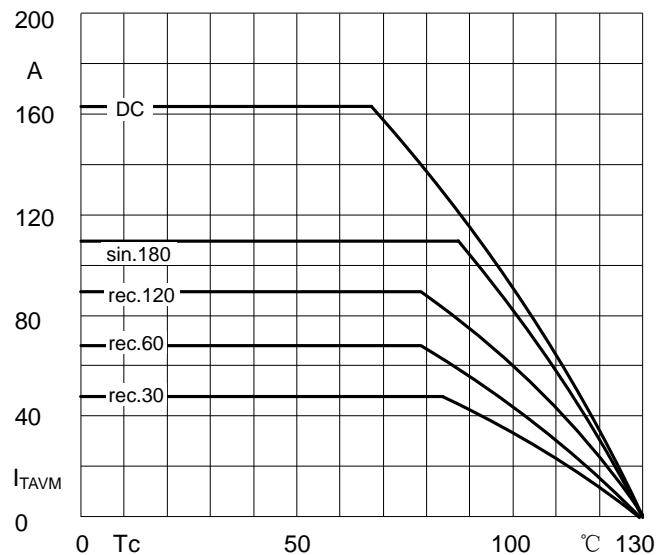


Fig2. Forward Current Derating Curve

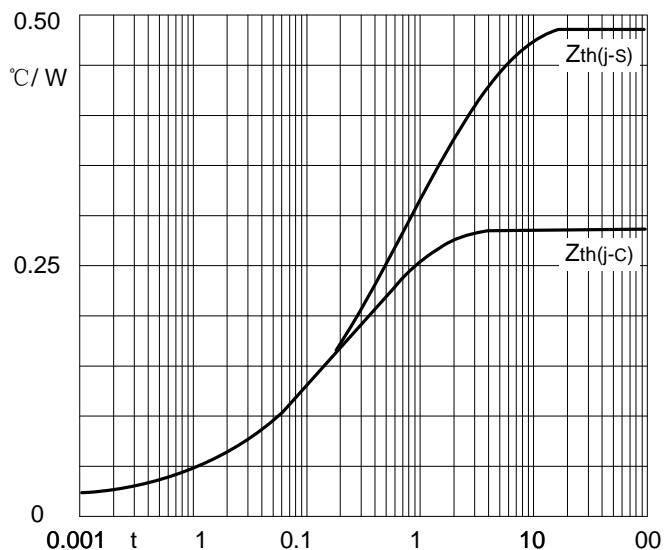


Fig3. Transient thermal impedance

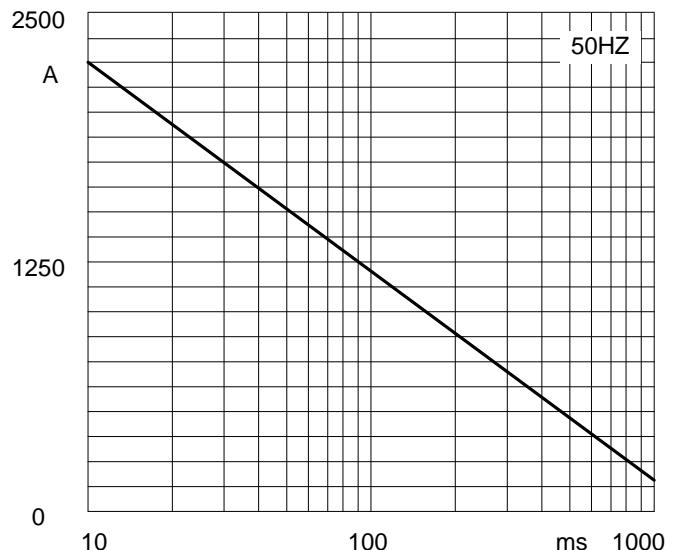


Fig4. Max Non-Repetitive Forward Surge Current

## Performance Curves

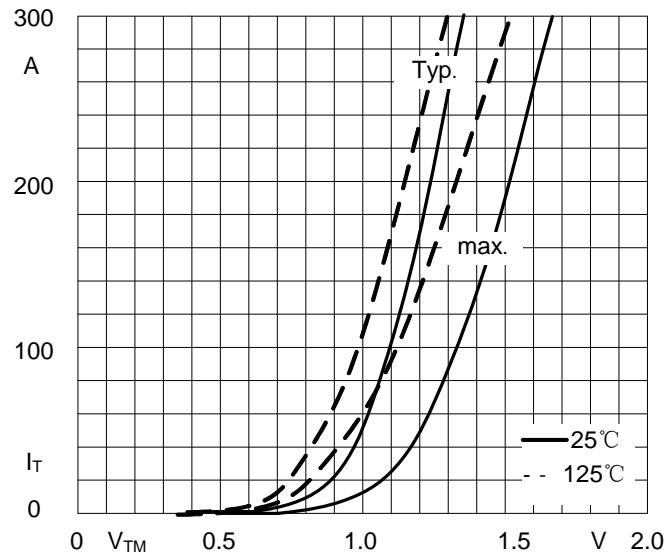


Fig5. Forward Characteristics

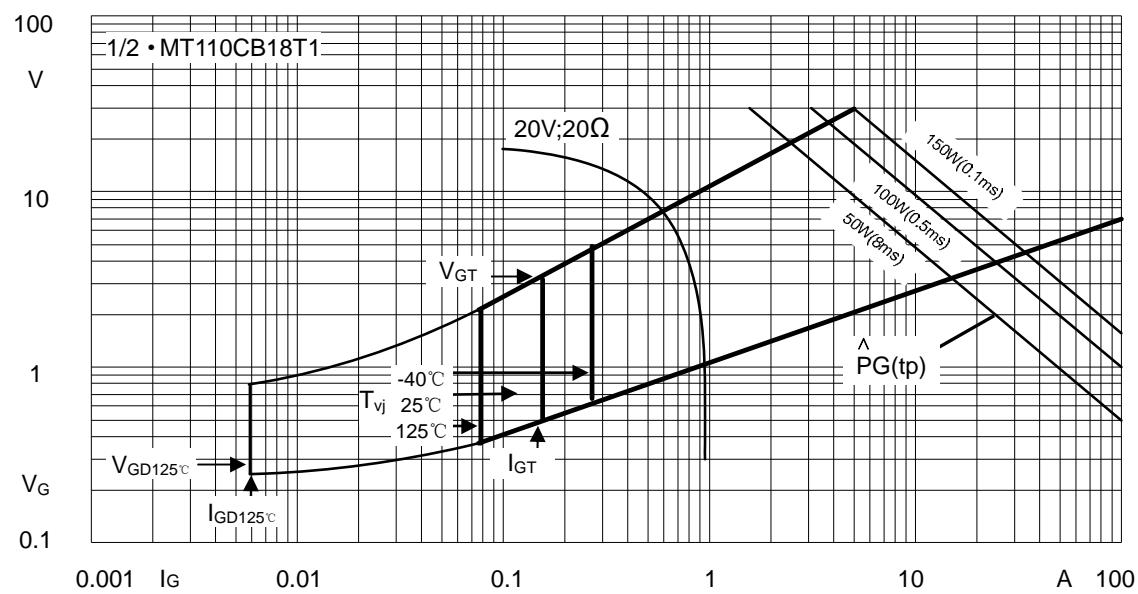


Fig6. Gate trigger Characteristics

## Ordering Information

Device	Packing
Part Number-BP	Bulk: 10PCS/BOX ;100PCS/CTN

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